

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
-30V	25m Ω @-10V	-6A
	36m Ω @-4.5V	

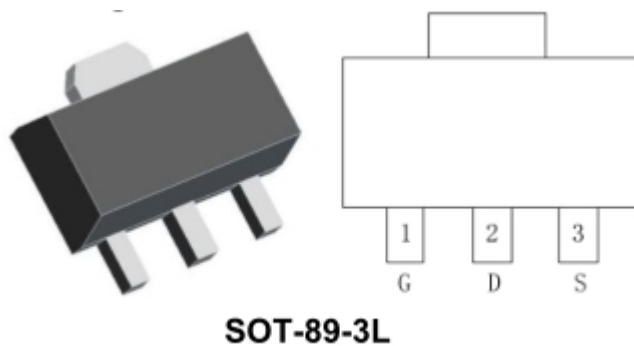
Feature

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage

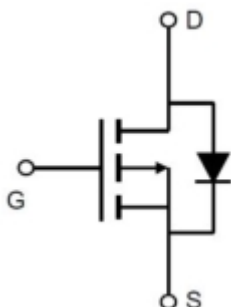
Application

- PWM application
- Load switch
- Battery charge in cellular handset

Package



Circuit diagram



Marking



Absolute maximum ratings

($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source Voltage	V_{DS}	-30	V
Gate-source Voltage	V_{GS}	± 20	V
Drain Current	I_D	-6	A
Pulsed Drain Current	I_{DM}	-24	A
Total Power Dissipation @ $T_c=25^{\circ}\text{C}$	P_D	1.5	W
Thermal Resistance Junction-to-Case @ Steady State	$R_{\theta JC}$	83.3	$^{\circ}\text{C}$
Junction and Storage Temperature Range	T_J, T_{STG}	-55~ +150	$^{\circ}\text{C}$

Electrical characteristics

($T_A=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV (BR)DSS	V _{GS} = 0V, I _D = -250μA	-30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -30V, V _{GS} = 0V			-1.0	μA
Gate-Source Leakage	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V			±100	μA
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1.0	-1.5	-2.5	V
Drain-Source On-Resistance ¹	R _{DS(on)}	V _{GS} = -10V, I _D = -4A		25	32	mΩ
		V _{GS} = -4.5V, I _D = -2A		36	45	
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} = -15V, V _{GS} =0V, f=1MHz		870		pF
Output Capacitance	C _{OSS}			130		
Reverse Transfer Capacitance	C _{rSS}			93		
Total Gate Charge	Q _g	V _{DS} = -15V , I _D = -5A, V _{GS} = -4.5V,		7.8		nC
Gate-Source Charge	Q _{gs}			2.7		
Gate-Drain Charge	Q _{gd}			2.8		
Switching Characteristics						
Turn-on Rise Time	T _{d(on)}	V _{DS} = -15V, I _D = -1A, V _{GS} = -10V, R _G =6Ω		6.5		nS
Turn-off Delay Time	T _r			8.8		
Turn-off Fall Time	T _{d(off)}			73		
Turn-On Delay Time	T _f			44		
Drain-Source Diode Characteristics						
Diode Forward Voltage	V _{SD}	I _{SD} = -1A,V _{GS} =0V		0.75	-1	V

Typical Characteristics

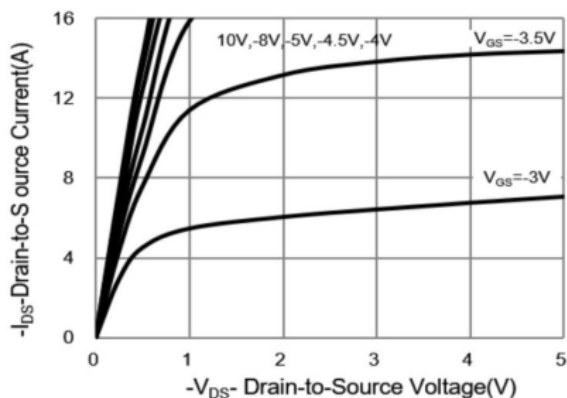


Fig.1 On-Region Characteristics

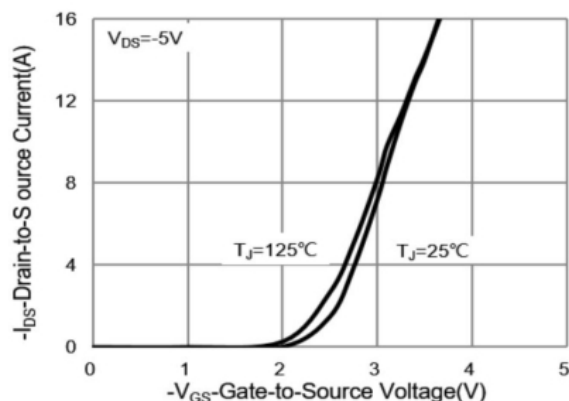


Fig.2 Transfer Characteristics

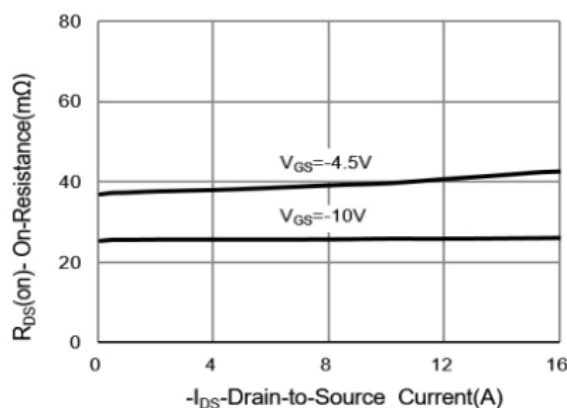


Fig.3 On-Resistance vs. Drain Current

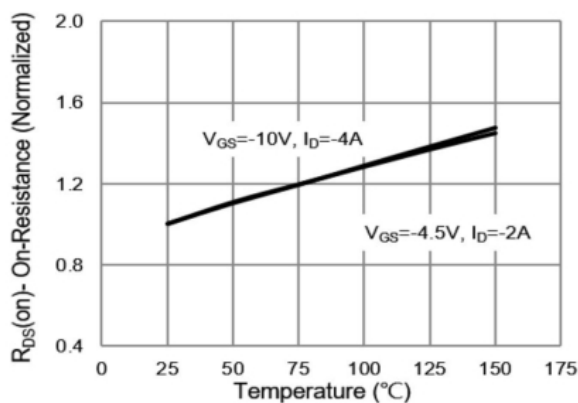


Fig.4 On-Resistance vs. Junction temperature

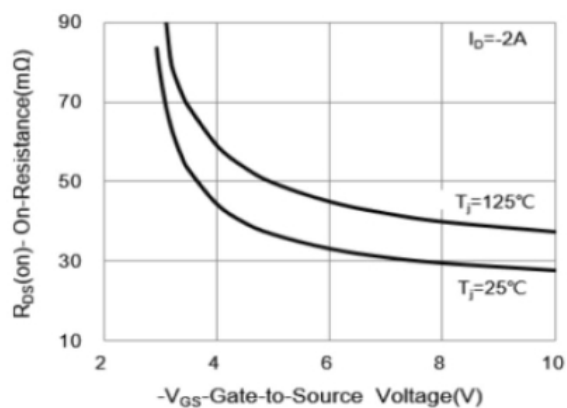


Fig.5 On-Resistance Variation with V_GS.

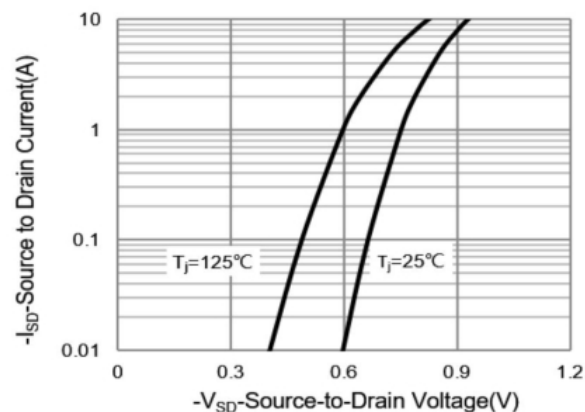


Fig.6 Body Diode Characteristics

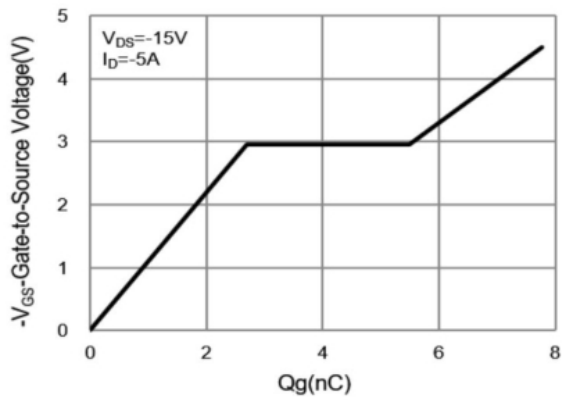


Fig.7 Gate-Charge Characteristics

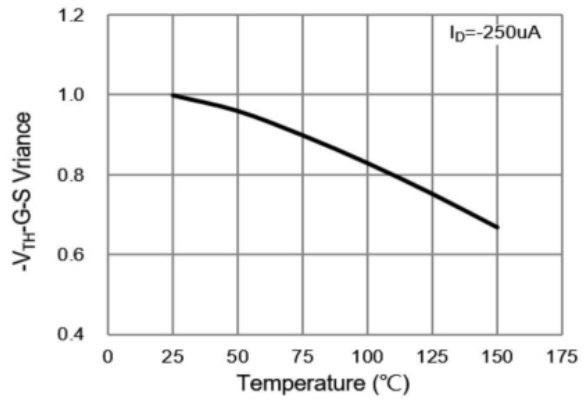


Fig.8 Threshold Voltage Variation with Temperature.

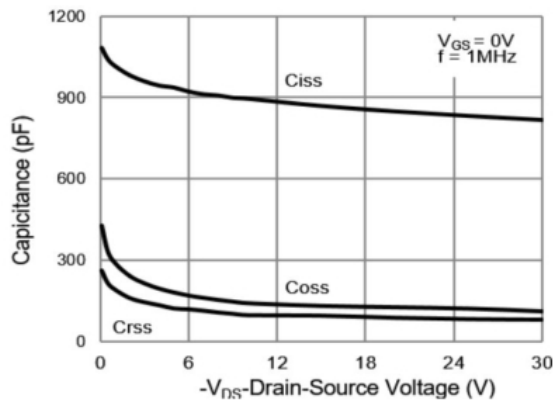
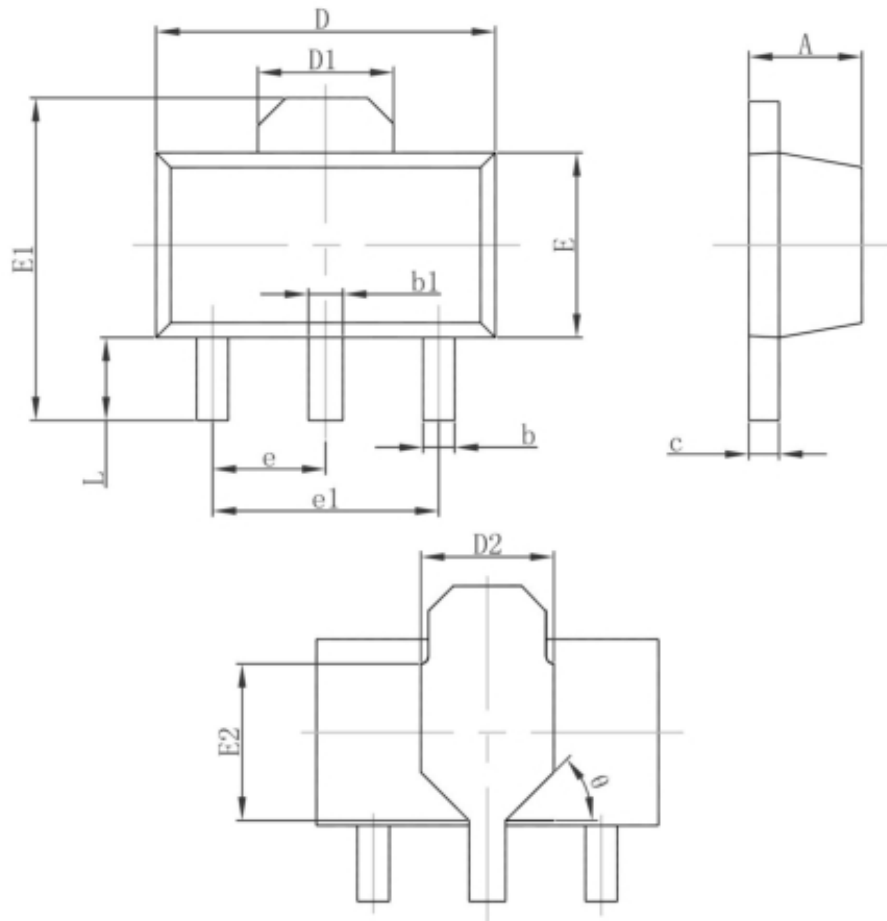


Fig.9 Capacitance vs. Drain-Source Voltage.

SOT-89-3L Package Information



Symbol	Dimensions In Millimeters	
	Min.	Max.
A	1.400	1.600
b	0.320	0.520
b1	0.400	0.580
c	0.350	0.440
D	4.400	4.600
D1	1.550 REF.	
D2	1.750 REF.	
E	2.300	2.600
E1	3.940	4.250
E2	1.900 REF.	
e	1.500 TYP.	
e1	3.000 TYP.	
L	0.900	1.200
θ	45°	